

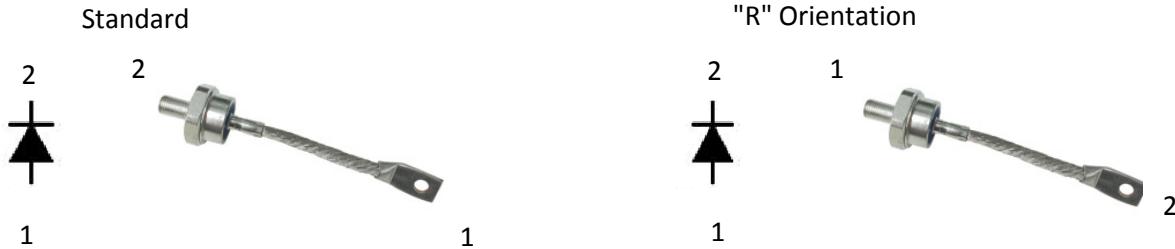
Silicon Standard Recovery Diode

V_{RRM} = 200 V - 1400 V
I_F = 150 A

Features

- High Surge Capability
- Types up to 1400 V V_{RRM}

DO-8 Package



Maximum ratings, at T_j = 25 °C, unless otherwise specified ("R" devices have leads reversed)

Parameter	Symbol	Conditions	1N4588(R)	1N4590(R)	1N4592(R)	1N4593(R)	Unit
Repetitive peak reverse voltage	V _{RRM}		200	400	600	800	V
DC blocking voltage	V _{DC}		200	400	600	800	V
Continuous forward current	I _F	T _C ≤ 110 °C	150	150	150	150	A
Surge non-repetitive forward current, Half Sine Wave	I _{F,SM}	T _C = 25 °C, t _p = 8.3 ms	3000	3000	3000	3000	A
I _{2t} for fusing	I _{2t}	60 Hz Half wave	37200	37200	37200	37200	A ² sec
Operating temperature	T _j		-60 to 200	-60 to 200	-60 to 200	-60 to 200	°C
Storage temperature	T _{stg}		-60 to 200	-60 to 200	-60 to 200	-60 to 200	°C

Electrical characteristics, at T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions	1N4588(R)	1N4590(R)	1N4592(R)	1N4593(R)	Unit
Diode forward voltage	V _F	I _F = 150 A, T _j = 110 °C	1.5	1.5	1.5	1.5	V
Reverse current	I _R	V _R = V _{RRM} , T _j = 110 °C	9.5	9	6.5	5.5	mA

Thermal characteristics

Thermal resistance, junction - case	R _{thJC}		0.35	0.35	0.35	0.35	°C/W
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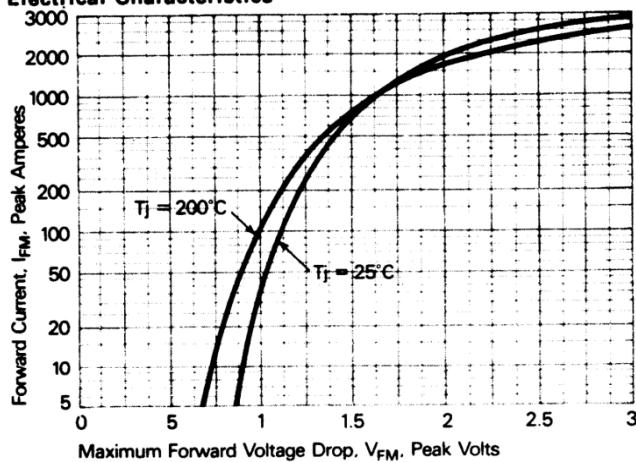
Electrical Characteristics


Figure 1. Forward current vs. Forward voltage.

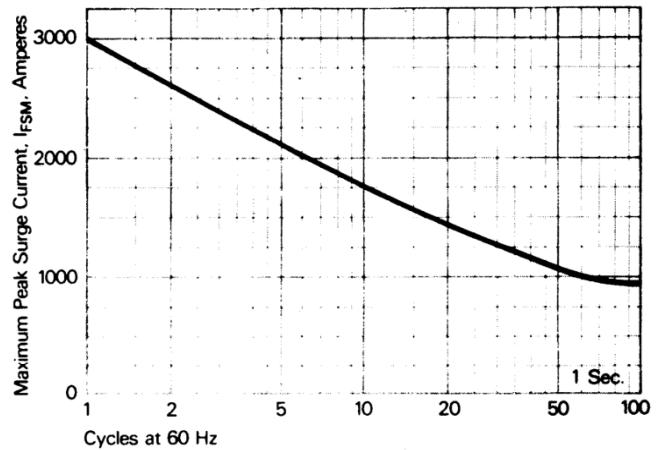


Figure 2. Maximum allowable surge current at rated load conditions.

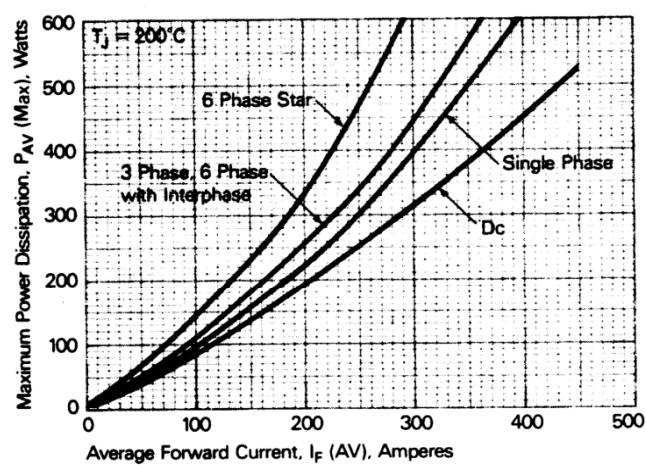


Figure 3. Power dissipation vs. Average forward current.

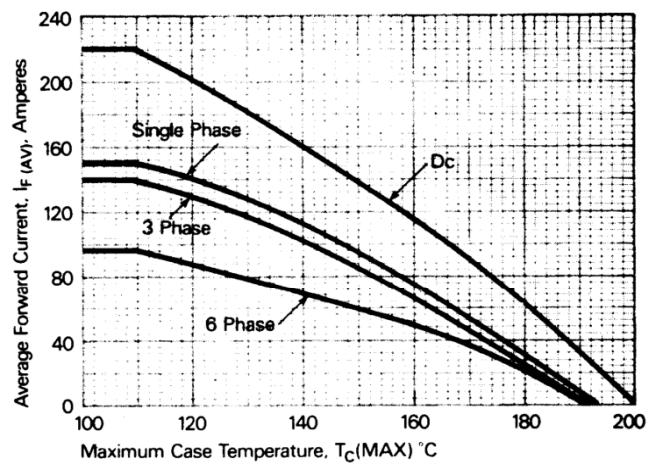


Figure 4. Forward current vs. Case temperature.